



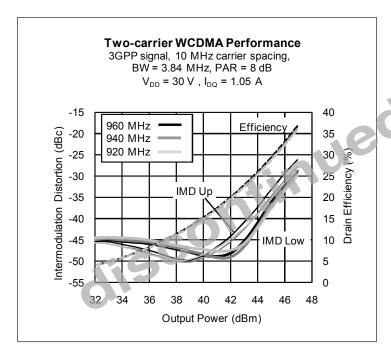
Thermally-Enhanced High Power RF LDMOS FETs 120 W, 920 – 960 MHz

Description

The PTFA091203EL is a 120-watt, internally-matched FET intended for use in power amplifier applications in the 920 to 960 MHz band. This device features internal I/O matching and thermally-enhanced open cavity ceramic package. Manufactured with Infineon's advanced LDMOS process, this device provides excellent thermal performance and superior reliability.

PTFA091203EL Package H-33288-6





Features

- Broadband internal matching
- Typical two-carrier WCDMA performance, 960 MHz, 30 V
 - Average output power = 28 W
 - Gain = 17 dB
 - Efficiency = 27%
 - Intermodulation Distortion = -36 dBc
- Typical CW performance, 960 MHz, 30 V
 - Output power at P_{1dB} = 140 W
 - Gain = 17 dB
 - Efficiency = 54%
- Integrated ESD protection: Human Body Model, Class 2 (minimum)
- Excellent thermal stability, low HCI drift
- Capable of handling 10:1 VSWR @ 30 V, 120 W (CW) output power
- Pb-free and RoHS-compliant

RF Characteristics

Two-carrier WCDMA Measurements (not subject to production test—verified by design/characterization in Infineon test fixture)

 $V_{DD} = 30 \text{ V}, I_{DO} = 1050 \text{ mA}, P_{OUT} = 28 \text{ W Avg}$

f₁ = 950 MHz, f₂ = 960 MHz, 3GPP signal, channel bandwidth = 3.84 MHz, peak/average = 8.0 dB @ 0.01% CCDF

Characteristic	Symbol	Min	Тур	Max	Unit
Gain	Gps	_	17	_	dB
Drain Efficiency	ηD	_	27	_	%
Intermodulation Distortion	IMD	_	-36	_	dBc

All published data at $T_{CASE} = 25^{\circ}C$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

Data Sheet – DISCONTINUED

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RF Characteristics (cont.)

Two-tone Measurements (tested in Infineon test fixture)

 V_{DD} = 30 V, I_{DQ} = 1050 mA, P_{OUT} = 110 W PEP, f = 960 MHz, tone spacing = 1 MHz

Characteristic	Symbol	Min	Тур	Max	Unit
Gain	G_ps	17	18	_	dB
Drain Efficiency	ηD	38	40	_	%
Intermodulation Distortion	IMD	_	-30	-28	dBc

DC Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}, I_{DS} = 10 \text{ mA}$	V _{(BR)DSS}	65	14)	_	V
Drain Leakage Current	$V_{DS} = 28 \text{ V}, V_{GS} = 0 \text{ V}$	I _{DSS}	.0	07	1.0	μΑ
Drain Leakage Current	$V_{DS} = 63 \text{ V}, V_{GS} = 0 \text{ V}$	I _{DSS}		_	10.0	μΑ
On-State Resistance	$V_{GS} = 10 \text{ V}, V_{DS} = 0.1 \text{ V}$	R _{DS(on)}	_	0.07	_	Ω
Operating Gate Voltage	$V_{DS} = 30 \text{ V}, I_{DQ} = 1050 \text{ mA}$	V_{GS}	2.0	2.5	3.0	V
Gate Leakage Current	$V_{GS} = 10 \text{ V}, V_{DS} = 0 \text{ V}$	I _{GSS}	_	_	1.0	μΑ

Maximum Ratings

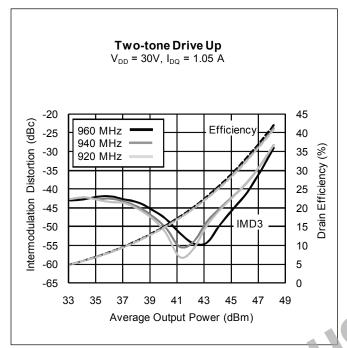
Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DSS}	65	V
Gate-Source Voltage	V_{GS}	-0.5 to +12	V
Junction Temperature	TJ	200	°C
Storage Temperature Range	T _{STG}	-40 to +150	°C
Thermal Resistance (T _{CASE} = 70°C, 120 W CW)	$R_{ hetaJC}$	0.42	°C/W

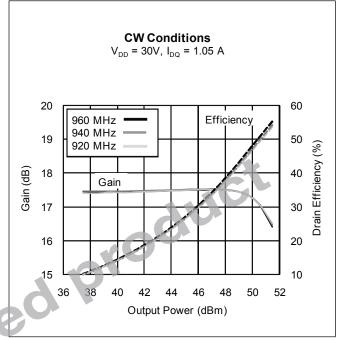
Ordering Information

Type and Version	Package Type	Package Description	Shipping
PTFA091203EL V4	H-33288-6	Thermally-enhanced slotted flange, single-ended	Tray
PTFA091203EL V4 R250	H-33288-6	Thermally-enhanced slotted flange, single-ended	Tape & Reel, 250 pcs

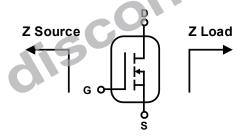


Typical Performance (data taken in a production test fixture)

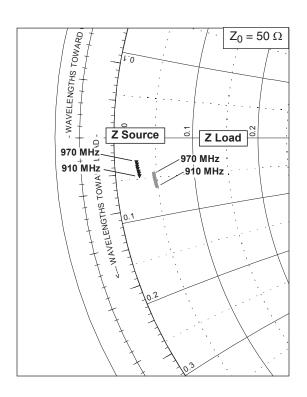




Broadband Circuit Impedance

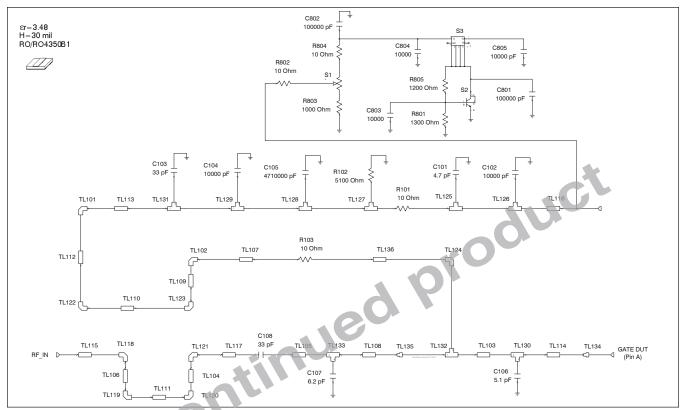


Frequency	Z Source Ω		Z Lo	ad Ω
MHz	R	jΧ	R	jΧ
910	1.42	-2.36	2.43	-3.11
920	1.40	-2.21	2.41	-2.97
930	1.38	-2.07	2.39	-2.83
940	1.35	-1.92	2.37	-2.68
950	1.33	-1.78	2.36	-2.54
960	1.32	-1.64	2.34	-2.40
970	1.30	-1.50	2.33	-2.26

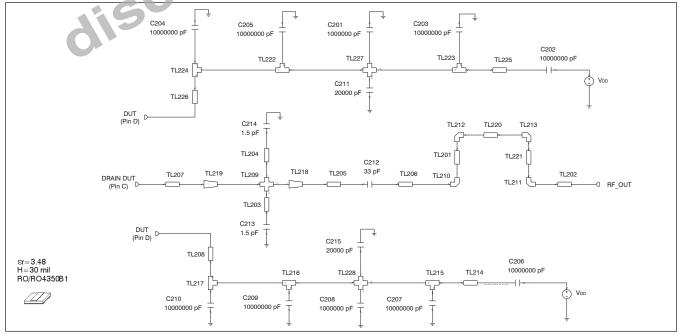




Reference Circuit



Reference circuit input schematic for f = 960 MHz





Description	
DUT	PTFA091203EL
PCB	0.760 mm [.030"] thick, εr = 3.48, Rogers 4350, 1 oz. copper

Electrical Characteristics at 960 MHz

Transmission	Electrical	Dimensions: mm	Dimensions: mils
Line	Characteristics		
Input			
TL101, TL102, TL122, TL123, TL124		W = 0.762	W = 30
TL103	0.059 λ, 8.94 Ω	W = 15.240, L = 10.287	W = 600, L = 405
TL104, TL106	0.040 λ, 51.58 Ω	W = 1.651, L = 7.620	W = 65, L = 300
TL105	0.086 λ, 38.82 Ω	W = 2.540, L = 15.900	W = 100, L = 626
TL107	0.007 λ, 78.27 Ω	W = 0.762, L = 1.270	W = 30, L = 50
TL108	0.002 λ, 38.82 Ω	W = 2.540, L = 0.330	W = 100, L = 13
TL109	0.015 λ, 78.27 Ω	W = 0.762, L = 2.921	W = 30, L = 115
TL110	0.098 λ, 78.27 Ω	W = 0.762, L = 19.050	W = 30, L = 750
TL111	0.004 λ, 51.58 Ω	W = 1.651, L = 0.762	W = 65, L = 30
TL112	0.026 λ, 78.27 Ω	W = 0.762, L = 5.080	W = 30, L = 200
TL113	0.014 λ, 36.29 Ω	W = 2.794, L = 2.642	W = 110, L = 104
TL114	0.039 λ, 8.94 Ω	W = 15.240, L = 6.731	W = 600, L = 265
TL115	0.033 λ, 51.58 Ω	W = 1.651, L = 6.302	W = 65, L = 248
TL116	0.001 λ, 36.29 Ω	W = 2.794, L = 0.254	W = 110, L = 10
TL117	0.007 λ, 51.58 Ω	W = 1.651, L = 1.270	W = 65, L = 50
TL118, TL119, TL120, TL121		W = 1.651	W = 65
TL125, TL126, TL127, TL128	0.011 λ, 36.29 Ω	W1 = 2.794, W2 = 2.794, W3 = 2.032	W1 = 110, W2 = 110, W3 = 80
TL129, TL131	0.012 λ, 36.29 Ω	W1 = 2.794, W2 = 2.794, W3 = 2.286	W1 = 110, W2 = 110, W3 = 90
TL130	0.015 λ, 8.94 Ω	W1 = 15.240, W2 = 15.240, W3 = 2.540	W1 = 600, W2 = 600, W3 = 100
TL132	0.004 λ, 8.94 Ω	W1 = 15.240, W2 = 15.240, W3 = 0.762	W1 = 600, W2 = 600, W3 = 30
TL133	0.000 λ, 38.82 Ω	W1 = 2.540, W2 = 2.540, W3 = 0.025	W1 = 100, W2 = 100, W3 = 1
TL134		W1 = 17.780, W2 = 12.700	W1 = 700, W2 = 500
TL135		W1 = 2.540, W2 = 15.240	W1 = 100, W2 = 600
TL136	0.003 λ, 78.27 Ω	W = 0.762, L = 0.508	W = 30, L = 20

table continued on page 6



Electrical Characteristics at 960 MHz				
Transmission	Electrical	Dimensions: mm	Dimensions: mils	
Line	Characteristics			
Output				
TL201, TL221	0.058 λ, 51.58 Ω	W = 1.651, L = 10.922	W = 65, L = 430	
TL202	0.014 λ, 51.58 Ω	W = 1.651, L = 2.720	W = 65, L = 107	
TL203, TL204	0.000 λ, 146.88 Ω	W = 0.025, L = 0.025	W = 1, L = 1	
TL205	0.014 λ, 38.82 Ω	W = 2.540, L = 2.540	W = 100, L = 100	
TL206	0.013 λ, 51.58 Ω	W = 1.651, L = 2.540	W = 65, L = 100	
TL207	0.128 λ, 10.17 Ω	W = 13.208, L = 22.352	W = 520, L = 880	
TL208, TL226	0.014 λ, 23.03 Ω	W = 5.080, L = 2.540	W = 200, L = 100	
TL209		W1 = 5.080, W2 = 0.025, W3 = 5.080	W1 = 200, W2 = 1, W3 = 200,	
		W4 = 0.025	W4 = 1	
TL210, TL211, TL212, TL213		W = 1.651	W = 65	
TL214, TL225	0.090 λ, 28.85 Ω	W = 3.810, L = 16.398	W = 150, L = 646	
TL215, TL223	0.021 λ, 28.85 Ω	W1 = 3.810, W2 = 3.810, W3 = 3.810	W1 = 150, W2 = 150, W3 = 150	
TL216, TL222	0.004 λ, 28.85 Ω	W1 = 3.810, W2 = 3.810, W3 = 0.762	W1 = 150, W2 = 150, W3 = 30	
TL217, TL224	0.021 λ, 23.03 Ω	W1 = 5.080, W2 = 5.080, W3 = 3.810	W1 = 200, W2 = 200, W3 = 150	
TL218 (taper)	0.015 λ , 23.03 Ω / 38.82 Ω	W1 = 5.080, W2 = 2.540, L = 2.794	W1 = 200, W2 = 100, L = 110	
TL219 (taper)	$0.064 \lambda, 10.17 \Omega / 23.03 \Omega$	W1 = 3.208, W2 = 5.080, L = 11.176	W1 = 520, W2 = 200, L = 440	
TL220	0.004 λ, 51.58 Ω	W = 1.651, L = 0.762	W = 65, L = 30	
TL227, TL228		W1 = 3.810, W2 = 2.540, W3 = 3.810	W1 = 150, W2 = 100, W3 = 150,	
		W4 = 2.540	W4 = 100	

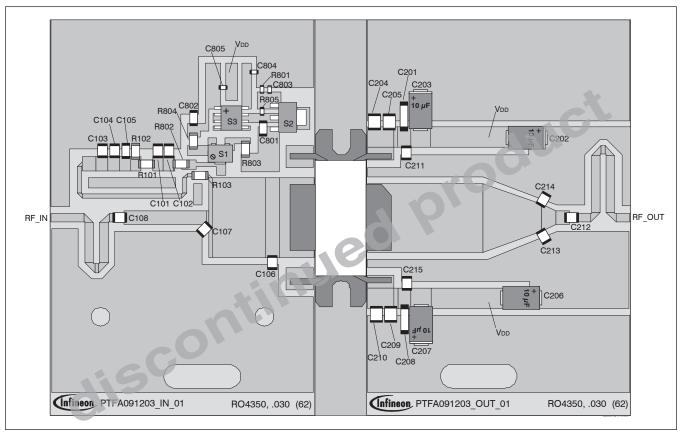
See further reference circuit information on next page



Circuit Assembly Information

Test Fixture Part No. LTN/PTFA091203EF

Find Gerber files for this test fixture on the Infineon Web site at http://www.infineon.com/rfpower



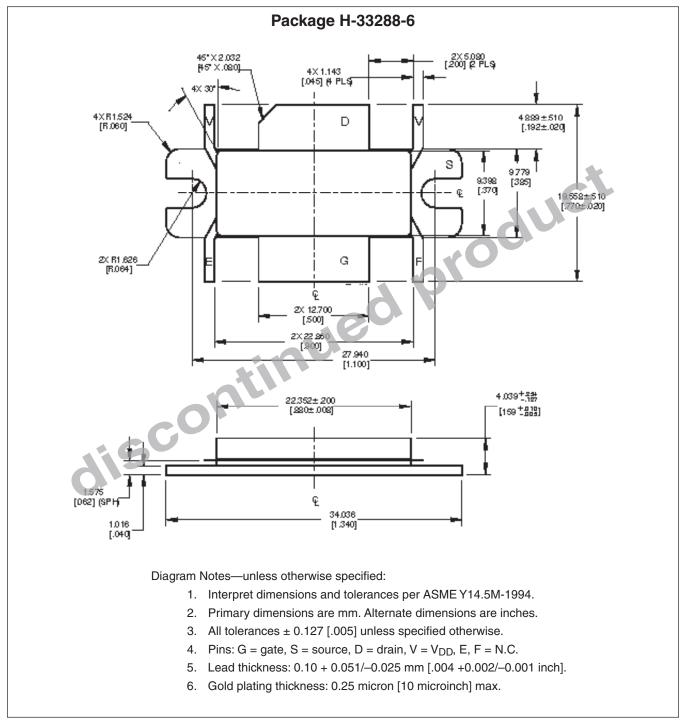
Reference circuit assembly diagram (not to scale)



Component	Description	Suggested Manufacturer	P/N
Input			
C101	Chip capacitor, 4.7 pF	ATC	ATC100B4R7BW500XB
C102	Chip capacitor, 10000 pF	ATC	ATC200B103MW
C103, C108	Chip capacitor, 33 pF	ATC	ATC100B330FW500XB
C104	Chip capacitor, 0.01 μF	ATC	ATC200B103MW
C105	Chip capacitor, 4.71 μF	Digi-Key	493-2372-2-ND
C106	Chip capacitor, 5.1 pF	ATC	ATC100B5R1BW500XB
C107	Chip capacitor, 6.2 pF	ATC	ATC100B6R2BW500XB
C801, C802	Chip capacitor, 0.1 µF	Digi-Key	PCC104BCT-ND
C803, C804, C805	Capacitor, 0.01 μF	Digi-Key	PCC1772CT-ND
R101, R103, R802, R804	Resistor, 10 Ω	Digi-Key	P10ECT-ND
R102	Resistor, 5100 Ω	Digi-Key	P5.1KECT-ND
R801	Resistor, 1300 Ω	Digi-Key	P1.3KGCT-ND
R803	Resistor, 1000 Ω	Digi-Key	P1.0KECT-ND
R805	Resistor, 1200 Ω	Digi-Key	P1.2KGCT-ND
S1	Potentiometer, 2k Ω	Digi-Key	3224W-202ECT-ND
S2	Transistor	Digi-Key	BCP5616TA-ND
S3	Voltage Regulator	Digi-Key	LM78L05ACM-ND
Output			
C201, C208	Chip capacitor, 1 μF	Digi-Key	478-3993-2-ND
C202, C203, C206, C207	Capacitor, 10 µF	Digi-Key	281M5002106K
C204, C205, C209, C210	Capacitor, 10 µF	Digi-Key	587-1818-2-ND
C211, C215	Chip capacitor, 20000 pF	ATC	ATC200B203MW
C212	Chip capacitor, 33 pF	ATC	ATC100B330FW500XB
C213, C214	Chip capacitor, 1.5 pF	ATC	ATC100B1R5BW500XB



Package Outline Specifications



Find the latest and most complete information about products and packaging at the Infineon Internet page http://www.infineon.com/rfpower

PTFA091203EL V4

Revision Hist	ory: 2013-05-16	Discontinued Data Sheet
Previous Versi	on: 2010-11-12 Data Sheet	
Page	Subjects (major changes since last revision)	
All	Product Discontinued. Please see PD Notes : PD_044_13	

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